

REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD

NOTES:

MATERIAL:

1. HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL :PHOSPHOR BRONZE $\phi=0.46\text{mm}$.
3. PLATING :SELECTING GOLD PLATING $3\mu\sim50\mu$ OVER NICKEL
4. SHIELD: :0.20mm THICKNESS COPPER ALLY WITH NICKEL PLATED

ELECTRICAL:

1. VOLTAGE RATING :125 VAC RMS.
2. CURRENT RATING :1.5 AMP.
3. CONTACT RESISTANCE :30 MILLIOHMS MAX.
4. INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

1. DURRABILITY: :750 CYCLES MIN.
2. PCB RETENTION PRE-SOLDER :1 LB MIN.

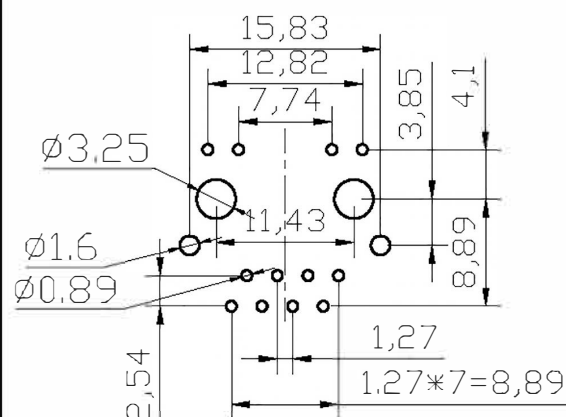
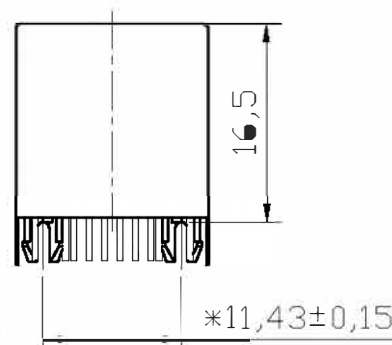
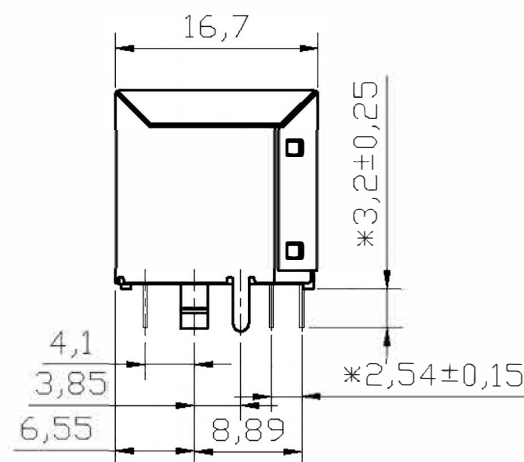
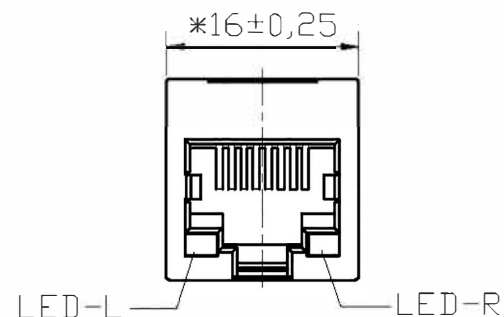
ENVIRONMENTAL:

1. STORAGE : -40° C TO 85° C.
2. OPERATION : 0° C TO 70° C.

PART NUMBER:

	ZP52E	X	X - X	X	X	X	X	X	X
52E SERIES JACK									
POSITIONS	CONTACTS	PORTS	LED	PEG/TAB	PLASTIC	COLOR	LOGO	GOLD PLATING	
4-4 POSITIONS 6-6 POSITIONS 8-8 POSITIONS 0-10 POSITIONS	2-2 CONTACTS 4-4 CONTACTS 6-6 CONTACTS 8-8 CONTACTS 1-10 CONTACTS	1-1PORTS 2-2PORTS 4-4PORTS 5-5PORTS 6-6PORTS 8-8PORTS	0-W/D SHIELD 1-Y/G 2-G/Y	0-W/D PEG 1-FRONT 3.05 2-BACK 3.85	1-PBT 2-NYLON66 3-NYLON46 4-ABS	1-BLACK 2-WHITE 3-GRAY 4-IVORY	0-W/D LOGO 1-W/ ZPY 2-W/ UL 3-W/ ZPY&UL	1-15u" 2-3u" 3-6u" 4-15u" 5-30u" 6-50u"	

DETAILS LISTS			DFTD: SHB		DATE: 2007.05.05		连兴旺电子（深圳）有限公司	
	TOLERANCES EXCEPT AS NOTED		CHKD: LANBD		DATE: 2007.05.05			
	 H1 D ± 0.15 ± D1 ± 0.075 ± D2 ± 0.05 ±		MFD:		DATE:			
			APPL:		DATE:			
	ANGLES ± 0.5		MATERIAL :		52E TOP ENYRY LED JACK			
		QTY :						
 THIRD ANGLE PROJECTION		FINISH :		DRAWING NO. TE52E1002		SIZE	REV	
		SCALE :		/PART NO.		A3	0	
				DO NOT SCALE DRAWING		SHEET X OF Y		



PC Board Layout
Component Side Shown